Requirements for UT assembling, testing and commissioning

LHCb upgrade electronics meeting **April 13, 2017** Burkhard Schmidt for the UT group

General Questions

- Do you need centralised support for a test-system, or will you do it yourselves?
 YES
- 2. Where will you do the tests?
 - In the new assembly hall 3852
- 3. When do you need the test infrastructure to be ready?
 - Last quarter of 2018 (cooling) and 1st quarter 2019 (DAQ)

UT and its infrastructure





Access side

UT assembly sequence

- The installation sequence will be as follows:
 - Put the infrastructure on the C-side in place (racks, chain, services etc.)
 - 2. Installation of the C-side detector box
 - 3. Installation of the A-side detector box
 - 4. Install/connect the infrastructure on the A-side
- The beam-pipe will be installed after 2 is completed



First design of cart for UT assembly



Area for UT assembling



- The area between 1-2 and A-B (7m x 7.6m, 3.5m high) is considered for UT
 - It will be prepared as a semi-clean room for detector assembling, with slight overpressure, filters and an airlock to enter.

Additional space for UT will be needed between 2-3 A-B for surveys (as we assemble from 2 sides).

- Further space will be needed for:
 - The LUCASZ cooling plant
 - Material storage
 - Control room space outside the clean room
- We need about ~7kW of cooling power for the tests we want to do (see next slides).
 - We count on the TC for support/resources

Electronics infrastructure

Power (UT contact is Carlos):

- 1. What type of Low Voltage system?
 - Wiener Maraton (could be part of the final setup/spares)
 - High Voltage will taken care for by us
- 2. How many power supply channels are required?
 ➢ Next slide
- 3. What copper-cabling is required?
 - > Discussion is still ongoing within the UT group
 - We count on help for powering up to the Maratons and the related infrastructure: PFCs, RCMs, cooling, WinCC panels, network

Infrastructure needs

- We intend to simultaneously power ½ of one detector side (thus ¼ of the full system) in the assembly area in 3852
 - This requires one complete service bay of power boards and cable sets planned for the cable trays.
 - The 4 PEPI chassis are an integral part of the detector half to be moved/installed as such
 - We need 3 Maratons to power ¼ of the full system
- The thermal cooling of ~7kW is needed for a service bay, 3 Maraton chassis and 2 (out of 4 total) active PEPI chassis



Infrastructure: Cooling

- Do you need cooling systems in building 3852?
 YES
- 2. If yes, please
 - i. Specify coolant,
 - We need both water and CO₂ cooling
 - ii. Temperature and power
 - For water: 7kW at bout 150C
 - For CO₂: 1.5kW (LUCASZ cooling plant)
 - iii. when these cooling systems are needed
 - End of 2018
- 3. Do you need compressed air or gas in the assembly areas?
 > YES
- 4. Please give an estimate of the total power of the equipment used in the assembly areas
 - See previous slide

Cooling option in the UT assembling area

LAUDA WK class WKL 7000

Circulation chiller



Description:

- Circulation chiller
- 1-line LED display for display of actual or set temperature and analogue pump pressure indication
- User-friendly menu guidance with simplest 3-key operation
- Electronic 2-point temperature control with hysteresis
- Safety elements for refrigerant pressure, coil temperature. Level indication
- Extremely powerful pressure pump
- Additional pump for internal circulation
- Filler opening at the front, drain tap
- Cooling capacity adjustment by solenoid valve control
- Air-cooled version

Technical Data:

Cost:

- not known yet, but smaller unit with
 2.2kW cooling output costs ~8.5kCHF
- Expect about 15kCHF for the larger unit

Working temperature range	-30 °C 40 °C
Ambient temperature range	5 °C 40 °C
Temperature control	±0.5 °C
Cooling output at 20 °C	7.0 kW
Pump pressure max.	6.0 bar
Pump flow max.	60 L/min
Filling volume max.	45 L
Overall Dimensions (W x D x H)	850 x 670 x 970 mm

Readout infrastructure





UT Optical Connection Needs

- Data concentrator boards (DCB) in the PEPI chassis.
 - Transfer event data out:

SALT → DCB (GBTx, VTTx) → TELL40

- Master control boards (MCB) in the PEPI chassis.
 - Generate master clocks for DCBs & SALT ASICs,
 - Distribute TFC to SALT,
 - Configure & read back SALT registers via ECS,
 - Read out temperature, voltage, humidity etc via ECS.
 MCB(GBTx, GBT-SCA, VTRx) ←→ SOL40
- LV monitor board in the service boxes.
 - Monitor LV parameters.

LV monitor board (GBTx, GBT-SCA, VTRx) $\leftarrow \rightarrow$ SOL40

Readout infrastructure

Optical fibres:

- 1. How many fibres are required?
 - We need 218 fibres for a single UT PEPI chassis
 - We intend to readout two chassis at the same time
- 2. What lengths are needed?
 - To be decided where to place a portable DAQ system
 - 30 m might be a reasonable estimate
- 3. What types of connectors & patching are required?
 - We need 24 MPO connections to the TELL40/SOL40.

Readout infrastructure

DAQ (the following is just a first iteration) :

1.	Number of PCIe40s?	11
2.	event-building required?	Νο
3.	Data need to be stored?	Yes, temporarily
4.	Data need to be processed?	To be decided
5.	In the FPGA? on the PC? What ki	nd of processing? On the PC
6.	Does data need to be monitored	? Yes
7.	At what granularity ?	single channel
8.	Do you have an existing data mo	nitoring system that you intend
	to integrate?	Νο
9.	How many work-places/screens	required on site? 3
10.	Remote access?	Yes
11.	Are you interested in a small-sca	le miniDAQ2 reference system
	being available at CERN in the ne	ear-future? Yes 14



UT Assembly & Testing Plan

Tentative stave assembly procedure:

- Fully-populated staves shipped to CERN
- C-frame with box, backplane pigtails assembled and ready.
- Box has removable cover panels on open sides and dry air flush
- Mont frame and stave, connect pigtail, connect cooling, etc.
- Power up, cool down, and read out in order to qualify staves for operation
- Repeat for all staves in four half-planes, working from beampipe region outward, populating planes U,V,X,X in order
- Frequency of tests with cool-down to be decided
- > Ideally, test everything possible before lowering half-UT into pit
- Proposed DAQ assembly:
 - DCBs will be housed in crates above the detector box.
 - They should be considered as part of the detector halves assembled on the surface
- Installation of LV and HV distribution:
 - LV and HV modules will be in the racks on the side of the detector or further away on the 'balcony' and installed independent on the detector halves
 - Some LV and HV will be needed on the surface for testing
 - Use some modules first there before installation in the cavern

Pigtail installation



- Given the available space all pigtails have to be installed prior to the mechanical support and the cooling plates for the PEPI
- We plan to do thorough testing on connectivity before and after mounting of the pigtails in the detector box.
- A gasket is foreseen at the interface to the box to ensure proper tightness to the interior of the box.

Some milestones assumed in the following

First batch of staves arrives at CERN

February 2019

Second batch of staves arrives at CERN

October 2019

- C-side detector half ready for installation November 2019
- > A-side detector half ready for installation

June 2020

Preparatory work for stave mounting



> Some tasks could be anticipated, if material arrives early enough

Mounting and Testing of UT C-side

2018

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			S	eptemb	er C	Octobe	r	Novem	ber	Decem	ber	January		Febru	ary	March		April		May	
Task Name	+ Duration	-	E B	M	E	ви	Е	B M	Е	B	Е	BM	Е	BN	1 E	B M	E	BN	E	BM	E
Preparation of UT C-side on the surface																					
Installation and alignment of C-frame	2 wks		Ť																		
Test assembly of UT-box in C-frame	1 mon					Ъ															
Alignment of top/bottom plate	1 wk						h i														
Installation and alignment of rails for frames/staves	1 mon						•	h													
Installation of 4 chassis for PEPI (top/bottom; front/back)	2 wks								-	1											
Installation of PEPI backplanes	2 wks																				
Installation of pigtails	1 mon										,	- h									
Electrical tests of pigtails after installation	1 mon													h							
Mouting of PEPI boards and testing	1 mon																				
Installation and testing of U-layer	12 wks														I						
Mouting of first frame and stave of U-layer (back)	1 wk															- h					
Test of first stave and the electronics chain (without HV)	1 wk															- İ h					
Complete installation of the 4 staves in the back of the U-layer	2 wks																				
Test of staves and electronics chain of the U-layer back	1 wk																	ĥ			
Full test of stave of the U-layer back with HV on sensors	2 wks																	*	h i		
Survey/alignment of 4 staves in the back of the U-layer	1 wk																		Ъ.		
Mount 4 staves in the front of the U-layer	1 wk																		+	h	
Test of staves and electronics chain of the U-layer front	1 wk																			Ъ.	
Full test of stave of the U-layer back with HV on sensors	1 wk																			- t h	1
Survey/alignment of staves in the front of the U-layer	1 wk																				Δ.
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Schedule assumes start of stave mounting in March 2019

- We foresee to do electronic tests in 2 steps
 - 1. Check of full electronics chain without HV on sensors
 - 2. Test with HV on sensors, which requires closing of the box etc.

Mounting and Testing of UT C-side

2019

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sk Name	- Duration -
Installation and testing of U-layer	12 wks
Mouting of first frame and stave of U-layer (back)	1 wk
Test of first stave and the electronics chain (without HV)	1 wk
Complete installation of the 4 staves in the back of the U-laye	2 wks
Test of staves and electronics chain of the U-layer back	1 wk
Full test of stave of the U-layer back with HV on sensors	2 wks
Survey/alignment of 4 staves in the back of the U-layer	1 wk
Mount 4 staves in the front of the U-layer	1 wk
Test of staves and electronics chain of the U-layer front	1 wk
Full test of stave of the U-layer back with HV on sensors	1 wk
Survey/alignment of staves in the front of the U-layer	1 wk
Installation and testing of V-layer	40 days
Install 4 staves in the back of the V-layer	1 wk
Test of staves and electronics chain of the V-layer back	1 wk
Full test of stave of the V-layer back with HV on sensors	1 wk
Survey/alignment of staves in the back of the V-layer	1 wk
Install 5 staves in the front of the V-layer	1 wk
Test staves and electronics chain of the V-layer front	1 wk
Full test of stave of the V-layer front with HV on sensors	1 wk
Survey/alignment of staves in the front of the V-layer	1 wk
Installation and testing of aX-layer	40 days
Install 4 staves in the back of the aX-layer	1 wk
Test of staves and electronics chain of the aX-layer back	1 wk
Full test of stave of the aX-layer back with HV on sensors	1 wk
Survey/alignment of staves in the back of the aX-layer	1 wk
Install 4 staves in the front of the aX-layer	1 wk
Test staves and electronics chain of the aX-layer front	1 wk
Full test of stave of the aX-layer front with HV on sensors	1 wk
Survey/alignment of staves in the front of the aX-layer	1 wk
Installation and testing of bX-layer	40 days
Install 4 staves in the back of the bX-layer	1 wk
Test of staves and electronics chain of the bX-layer back	1 wk
Full test of stave of the bX-layer back with HV on sensors	1 wk
Survey/alignment of staves in the back of the bX-layer	1 wk
Install 5 staves in the front of the bX-layer	1 wk
Test staves and electronics chain of the bX-layer front	1 wk
Full test of stave of the bX-layer front with HV on sensors	1 wk
Survey/alignment of staves in the front of the bX-layer	1 wk
Final checks and readying of UT-C-side for installation	2 wks
JT C-side ready for installation	0 days

Schedule assumes start of stave mounting in March 2019 C-side would be ready for installation in LHCb in November 2019 The installation and testing of aX and bX could go on in parallel which provides a contingency of about 40 days

Mounting and Testing of UT A-side

2019

2020



Schedule assumes start of stave mounting in December 2019 (after completion of the C-side)

- A-side would be ready for installation in LHCb in June 2020
- > The installation and testing of aX and bX is assumed to go on in parallel.
- More parallelism could be foreseen for U and V layers.
- This would provide a contingency of about 40 days.